
2SD1471

Silicon NPN Planar, Darlington

HITACHI

ADE-208-1154 (Z)

1st. Edition

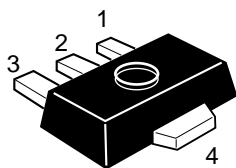
Mar. 2001

Application

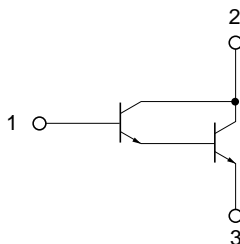
High gain amplifier

Outline

UPAK



1. Base
2. Collector
3. Emitter
4. Collector (Flange)



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	40	V
Collector to emitter voltage	V_{CEO}	30	V
Emitter to base voltage	V_{EBO}	10	V
Collector current	I_C	300	mA
Collector peak current	$i_{C(peak)}^{*1}$	500	mA
Collector power dissipation	P_C^{*2}	1	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. Pulse ≤ 10 ms, Duty cycle ≤ 20%
2. Value on the alumina ceramic board (12.5 x 30 x 0.7 mm)

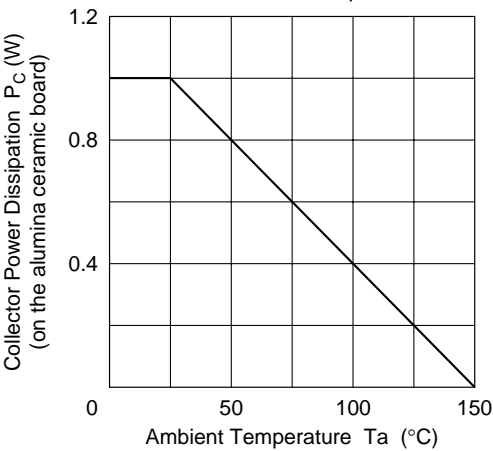
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	40	—	—	V	$I_C = 10\text{ }\mu\text{A}$, $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	30	—	—	V	$I_C = 1\text{ mA}$, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	10	—	—	V	$I_E = 10\text{ }\mu\text{A}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	1	μA	$V_{CB} = 30\text{ V}$, $I_E = 0$
	I_{CEO}	—	—	10	μA	$V_{CE} = 24\text{ V}$, $R_{BE} = \infty$
DC current transfer ratio	h_{FE1}^{*1}	2000	—	100000		$V_{CE} = 5\text{ V}$, $I_C = 10\text{ mA}^{*2}$
	h_{FE2}^{*1}	3000	—	—		$V_{CE} = 5\text{ V}$, $I_C = 100\text{ mA}^{*2}$
	h_{FE3}^{*1}	3000	—	—		$V_{CE} = 5\text{ V}$, $I_C = 400\text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.5	V	$I_C = 100\text{ mA}$, $I_B = 0.1\text{ mA}^{*2}$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	2.0	V	$I_C = 100\text{ mA}$, $I_B = 0.1\text{ mA}^{*2}$

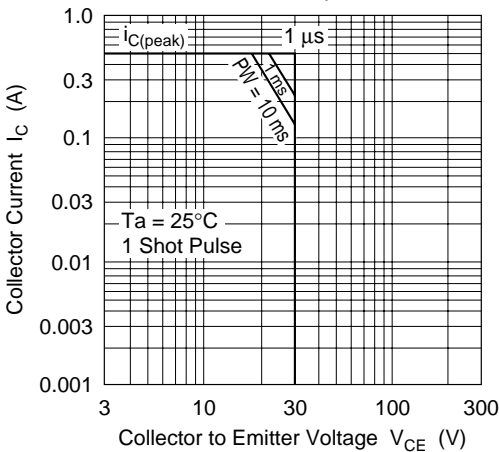
Notes: 1. The 2SD1471 is grouped by h_{FE} as follows.
2. Pulse test

Mark	DT	ET
h_{FE1}	2000 to 100000	5000 to 100000
h_{FE2}	3000 min	10000 min
h_{FE3}	3000 min	10000 min

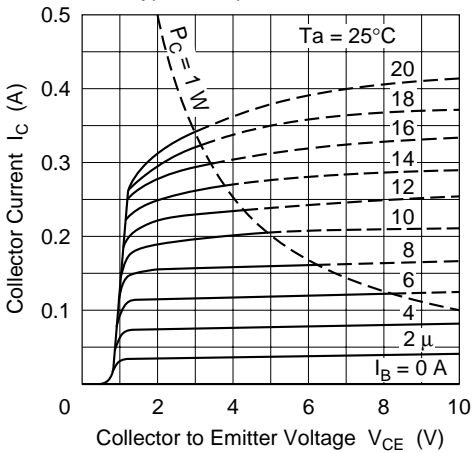
Maximum Collector Dissipation Curve



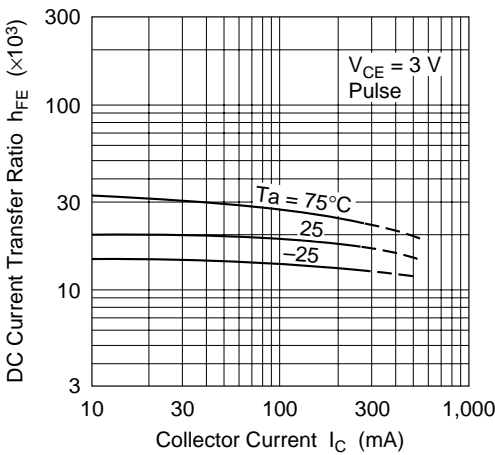
Area of Safe Operation

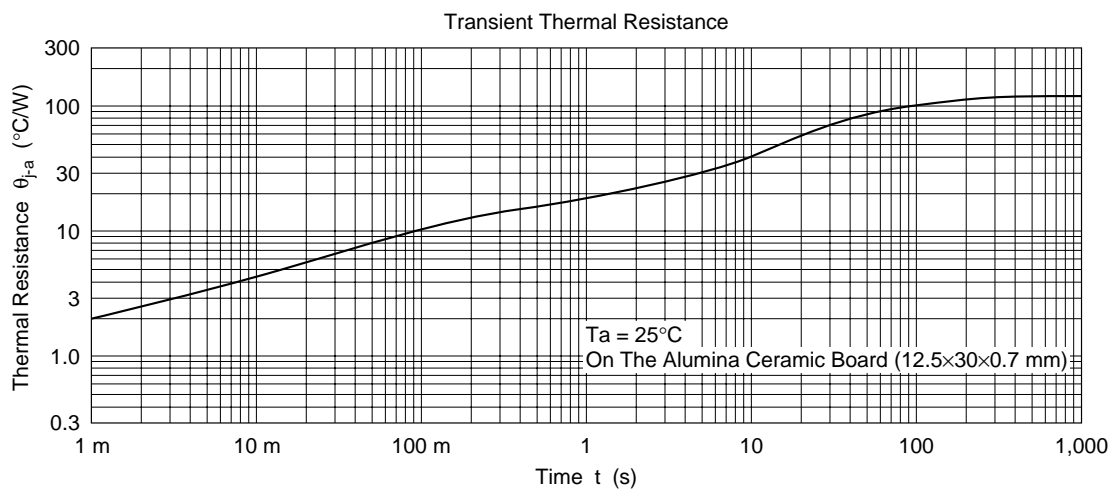
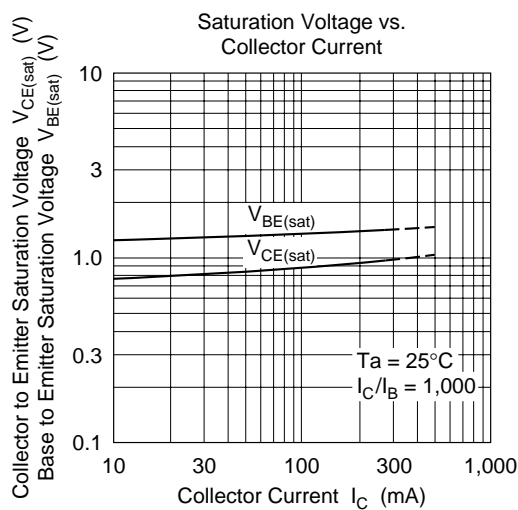


Typical Output Characteristics



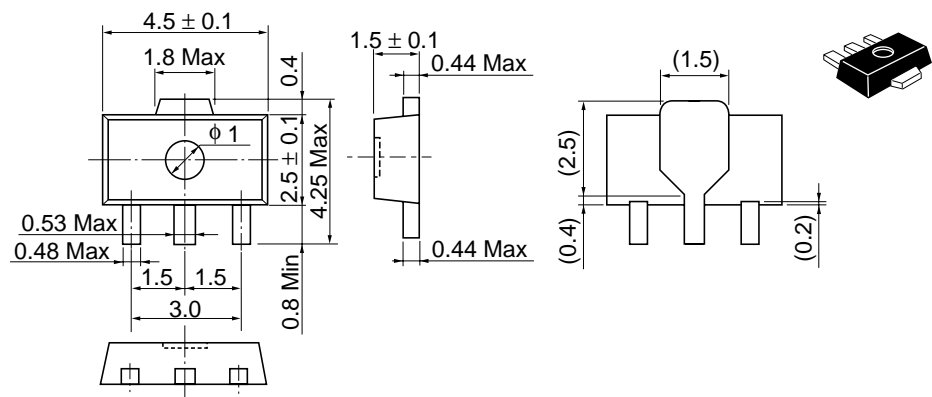
DC Current Transfer Ratio vs. Collector Current





Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	UPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.050 g

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